

STP9N80K5, STW9N80K5

N-channel 800 V, 0.73 Ω typ., 7 A MDmesh™ K5 Power MOSFETs in a TO-220 and TO-247 packages

Datasheet - production data

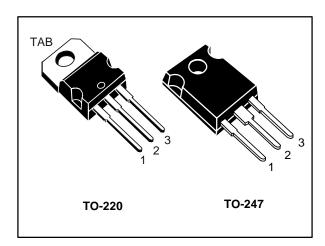
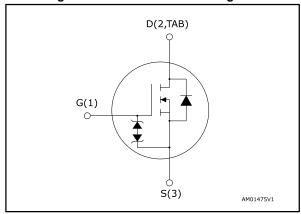


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ΙD
STP9N80K5	800 V	0.00.0	7.4
STW9N80K5	800 V	0.90 Ω	7 A

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

These very high voltage N-channel Power MOSFET are designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STP9N80K5	ONIOOKE	TO-220	Tuba
STW9N80K5	9N80K5	TO-247	Tube

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	± 30	V
I_D	Drain current (continuous) at T _C = 25 °C	7	Α
I _D	Drain current (continuous) at T _C = 100 °C	4.4	Α
I _D ⁽¹⁾	Drain current (pulsed)	28	Α
Ртот	Total dissipation at T _C = 25 °C	110	W
dv/dt (2)	Peak diode recovery voltage slope	4.5	\
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
TJ	Operating unction temperature range	FF to 150	°C
T _{stg}	Storage temperature range	- 55 to 150	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value		Value		Unit
		TO-220	TO-247			
R _{thj-case}	Thermal resistance junction-case	1.14		°C/W		
R _{thj-amb}	Thermal resistance junction-ambient	62.5	50	°C/W		

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by Tjmax)	2.4	Α
Eas	Single pulse avalanche energy (starting Tj = 25 °C, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)	200	mJ

⁽¹⁾Pulse width limited by safe operating area.

 $^{^{(2)}}I_{SD} \leq 7$ A, di/dt ≤ 100 A/ $\mu s;$ V Ds peak < V(BR)DSS,VDD= 640 V

 $^{^{(3)}}V_{DS} \le 640 \text{ V}$

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			V
		V _{GS} = 0 V, V _{DS} = 800 V			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 \text{ °C}^{(1)}$			50	μΑ
I _{GSS}	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 3.5 \text{ A}$		0.73	0.90	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		ı	340	-	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	1	37	-	pF
Crss	Reverse transfer capacitance	VG3 - V	ı	0.65	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	V _{GS} = 0 V, V _{DS} = 0 to 640 V	ı	61	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	V _{GS} = 0 V, V _{DS} = 0 to 640 V		22		pF
Rg	Intrinsic gate resistance	f = 1 MHz open drain	ı	7	-	Ω
Q_g	Total gate charge	$V_{DD} = 640 \text{ V}, I_{D} = 7 \text{ A}$	-	12	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	3.8	-	nC
Q_{gd}	Gate-drain charge	See (Figure 16: "Test circuit for gate charge behavior")		6.7	-	nC

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 400 V, I_{D} =3.5 A, R_{G} = 4.7 Ω	-	11		ns
tr	Rise time	V _{GS} = 10 V	-	5.7	-	ns
t _{d(off)}	Turn-off delay time	See (Figure 15: "Test circuit for resistive load switching times" and	-	65.3	-	ns
t _f	Fall time	Figure 20: "Switching time waveform")	1	13.6	ı	ns



 $[\]ensuremath{^{(1)}}\mbox{Defined}$ by design, not subject to production test.

 $^{^{(1)}}$ Co(tr) is a constant capacitance value that gives the same charging time as Coss while V_{DS} is rising from 0 to 80% V_{DSS}.

 $^{^{(2)}}$ Co_(e1) is a constant capacitance value that gives the same stored energy as Coss while V_{DS} is rising from 0 to 80% V_{DSS}.

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		7	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		28	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 7 A, V _{GS} = 0 V	-		1.5	V
t _{rr}	Reverse recovery time	I _{SD} = 7 A, di/dt = 100 A/μs,	-	292		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V See Figure 17: "Test circuit for	-	2.66		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times"	-	18.2		Α
t _{rr}	Reverse recovery time	I _{SD} = 7 A, di/dt = 100 A/μs	-	477		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$ See Figure 17: "Test circuit for	-	3.91		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times"	-	16.4		А

Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V(BR)GSO	Gate-source breakdown voltage	$I_{GS}= \pm 1 \text{mA}, I_{D}= 0 \text{ A}$	30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

10

10⁻²

2.1 Electrical characteristics (curves)

Figure 2: Safe operating area

ID
Operation in this area is limited by R_{DS(on)}

101

101

t_p=100 µs
t_p=1 ms

T_i≤150 °C

T_o= 25°C

single pulse

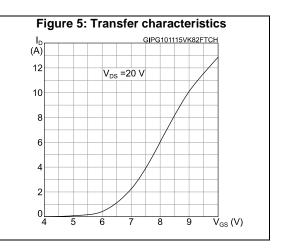
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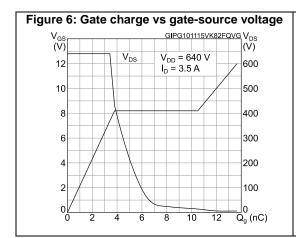
10²

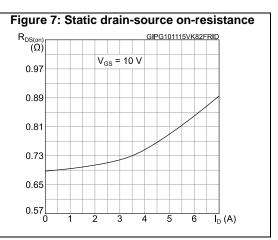
t_p=10 ms

 $\overline{V}_{DS}(V)$

Figure 3: Thermal impedance $K \\ \delta = 0.5 \\ \delta = 0.5 \\ \delta = 0.1 \\ 10^{-1} \\ Z_{in} = k^*R_{thjec} \\ \delta = t_p/T \\ \delta = 0.02 \\ \delta = 0.01 \\ SINGLE PULSE \\ 10^{-2} \\ 10^{-3} \\ 10^{-1} \\ t_p(s)$







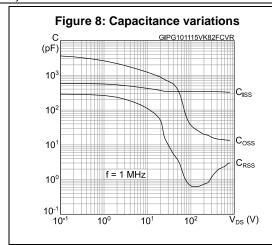


Figure 10: Normalized on-resistance vs temperature

R_{DS(on)} GIPG101115VK82FRON
(norm.)

2.6

2.2

1.8

1.4

1.0

0.6

0.2

-75

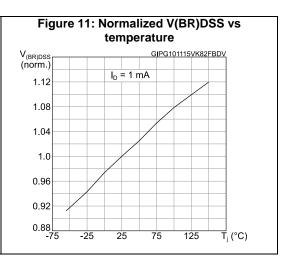
-25

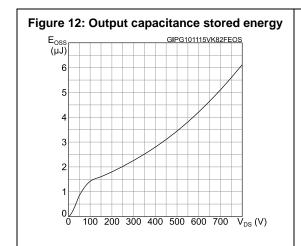
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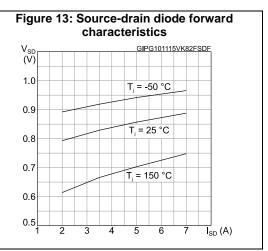
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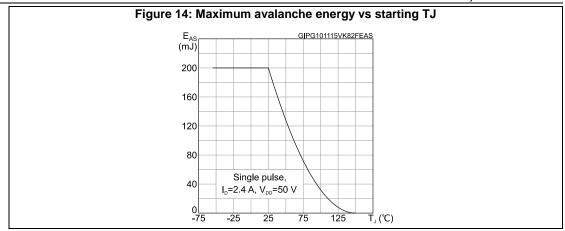
125

T_j (°C)









3 Test circuits

Figure 15: Test circuit for resistive load switching times

Figure 16: Test circuit for gate charge behavior

12 V 47 kΩ 100 nF D.U.T.

VGS 1 kΩ VGB

12 V 47 kΩ VGB

14 KΩ VGB

AM01469v1

Figure 17: Test circuit for inductive load switching and diode recovery times

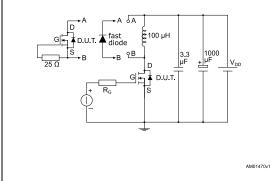


Figure 18: Unclamped inductive load test circuit

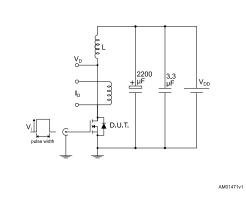


Figure 19: Unclamped inductive waveform

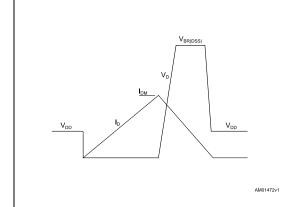
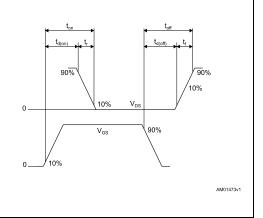


Figure 20: Switching time waveform



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-220 type A package information

Figure 21: TO-220 type A package outline

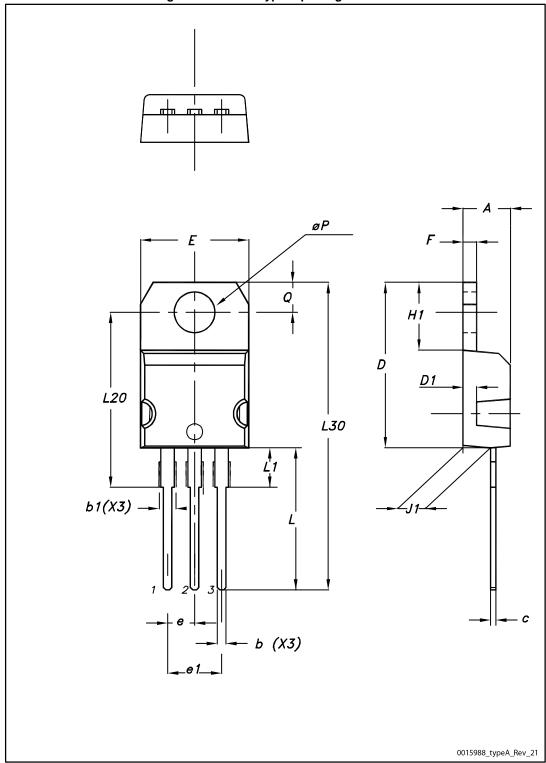


Table 10: TO-220 type A mechanical data

		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øΡ	3.75		3.85
Q	2.65		2.95

4.2 TO-247 package information

Figure 22: TO-247 package outline

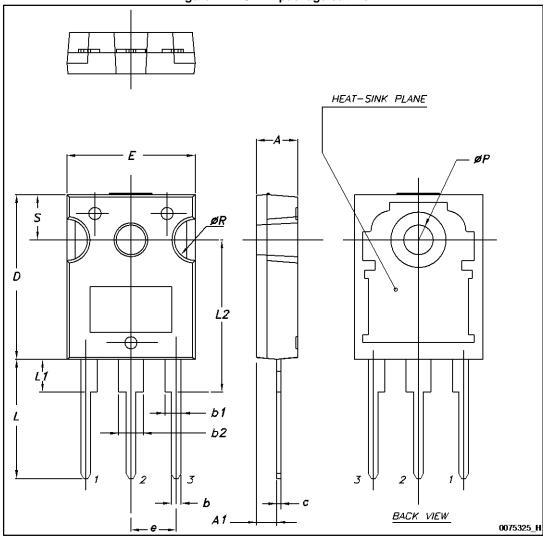


Table 11: TO-247 package mechanical data

Dim.	mm			
	Min.	Тур.	Max.	
А	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
Е	15.45		15.75	
е	5.30	5.45	5.60	
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
ØP	3.55		3.65	
ØR	4.50		5.50	
S	5.30	5.50	5.70	

5 Revision history

Table 12: Document revision history

Date	Revision	Changes	
13-Oct-2015	1	First release.	
20-May-2016	2	Modified: Table 4: "Avalanche characteristics", Table 6: "Dynamic", Table 7: "Switching times" and Table 8: "Source-drain diode". Minor text changes	
26-Jul-2016	3	Updated features in cover page.	

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